

A Cache Primer

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In the pursuit of raw computing horsepower, designers often try to improve throughput of designs through an increase in CPU clock frequency. But at a certain point, bus bandwidth and access speed to main memory become the limiting factors in overall processor throughput. This limitation may be overcome with faster, more expensive memory. However, at some point economic feasibility becomes an issue. A good cache memory design and implementation can help to minimize bus latency and improve overall processor throughput, all with modest economic cost.

1 What is a Cache?

A cache is commonly defined as a secure place of storage, mainly for preserving provisions or implements. A cache, as it applies to computing, is a small block of high speed memory, employed to make a CPU with a large amount of slow, inexpensive memory think it has immediate, and very fast, access to that large bank of slow memory. The goal of a cache in computing is to keep the expensive CPU as busy as possible by minimizing the wait for reads and writes to slower memory.

To help explain a cache, here is a simple example of a cook working in a restaurant kitchen. To maintain the ultimate in freshness, every time an order comes into the kitchen, the cook runs out to the supermarket across the street and buys all the ingredients needed to fill the order. This is time consuming, and as business grows, it starts to limit the total number of orders he can cook during a given mealtime; besides, customers become

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agitated at the time it takes to prepare the food. The cook, being a smart man, sits down one night and analyzes all the orders for the previous week. He notices a trend—that there is a great amount of commonality in the ingredients in all orders. He buys a refrigerator to store the most commonly used items, and saves himself some trips to the supermarket. To increase his efficiency further, he organizes his products on the shelves of the refrigerator and creates a list of the items on hand and posts it on the refrigerator door. Now when an order comes in, he checks the list to see if he has the necessary ingredients on hand, and if not he can run across the street.

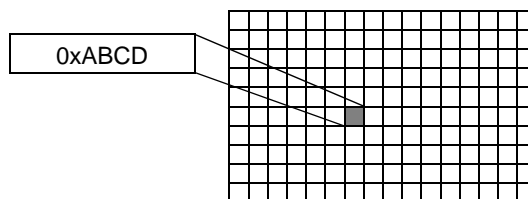
This is the concept behind cache. In this example, the cook is the expensive resource, the CPU, the supermarket is the large amount of RAM in a system, the cache is the refrigerator, and the list is the cache directory.

The cook and restaurant example is somewhat simplified. For example, what happens when the refrigerator gets full. The cook might throw away the oldest ingredient in the refrigerator, or possibly the ingredient that has the nearest expiration date. Disposing items based on freshness or expiration date is analogous to a cache's replacement algorithm.

2 Associativity

A cache is essentially a small, but fast, memory that is separate from a processor's main memory. A cache's associativity determines how main memory locations map into cache memory locations. A cache is said to be fully associative if its architecture allows any main memory location to map into any location in the cache. In a fully associative cache, a directory shows the mappings of main memory to cache memory locations. A directory location is then assigned whenever something is put in cache. Problems arise with full associativity when searching through the cache array for an entry. With a large cache, scanning the directory can be time consuming and usually requires either a great many expensive CPU cycles, or additional hardware support such as a content addressable memory (CAM). Unfortunately large CAMs are expensive, so other methods for traversing through a cache were developed.

Associativity is a little difficult to imagine in the cook and refrigerator example, so here is a more numerical example. Imagine, for example, an SDRAM based memory system that has addresses from 0x0000–0xFFFF. Furthermore, assume that the 4 most significant address bits describe a row, and the last 12 bits describe columns within a row. A cache can be imagined with enough room to hold 0xFFF entries, which accounts for all columns. An SDRAM address can then be stored in the cache based on its column address. For example, address 0xABCD would be stored at cache address 0xBCD. The directory would still contain all 0xFFF entries in the cache, however each entry would be at the location in the directory matching the column address, so only the row address would actually need to be written in the directory. Since the SDRAM is 16 times larger than the cache, 16 SDRAM address would map to each cache entry. In the above example, for an access to address 0xABCD, a 0xA is written to the directory entry for 0xBCD and the actual data to be cached would be stored at location 0xBCD. This takes away the decision on where to store the new cache entry. This is called a set-associative architecture.



Directory		
Valid	Tag	Set
1	0x2	0xBCA
0		0xBCB
1	0x0	0xBCC
1	0xA	0xBCD
1	0xC	0xBCE
0		0xBCF

Figure 1. Set-Associative Example

With a set-associative architecture there is no need for a big CAM or cross reference to determine which cache location contains which addresses; the directory address is based on the main memory address. In Figure 1, the column address is the cache’s set address. Within any set, the entry is associative and can have any row address. These row addresses are referred to as the tag bits.

It seems that a set-associative cache would provide a less flexible cache design; what would drive someone to use a set-associative cache over a fully associative cache? The quick answer is speed. Each access to a fully associative cache must begin with the processor scanning a directory for the address matching the associated memory. A set-associative cache reduces this latency dramatically. For a read cycle, in the above example the lower 12 bits of address are routed to both the cache and the RAM. While the cache finds the entry based on these lower bits, the column address in this case, the directory looks at the upper 4 bits to tell if there is a match. Cache address 0xBCD is accessed and ready to go, waiting for the directory to tell the CPU if there is a match between the stored tag, 0xA, or whether there is some other address tag in that slot. In this case, the data can be made available while the tag match is being made. In a fully associative cache, a complete match must be made before data can be accessed.

A greater degree of associativity, or more ways in the cache, improves hit rates within a cache. Each way is a copy of the cache, with its own set RAM and its own tag RAM. An *n*-way set-associative cache will have *n* set RAM’s and *n* tag RAM’s. In Table 1 the set 0xBCD has two different valid tags, corresponding to address 0xABCD and 0xDBCD.

Table 1. Two Way Set-Associative Cache

Way 1			Way 2		
Valid	Tag	Set	Valid	Tag	Set
1	0xA	0xBCA	1	0x2	0xBCA
0		0xBCB	0		0xBCB
0		0xBCC	1	0x0	0xBCC
1	0xD	0xBCD	1	0xA	0xBCD
0		0xBCE	1	0xC	0xBCE
1	0x2	0xBCF	0		0xBCF

A cache’s hit rate increases with more ways. [Figure 2](#) demonstrates that beyond a certain point, increasing cache size has more of an impact than increasing associativity.

NOTE

The data for [Figure 2](#) and [Figure 3](#) was obtained through a cache simulator while simulating the GCC compiler. Associativity was varied, as well as cache size.

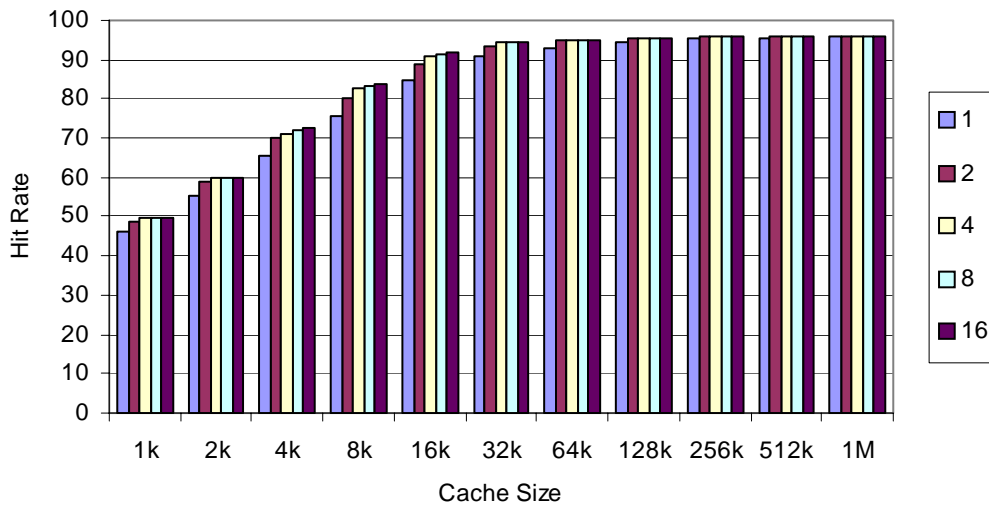


Figure 2. Varying Associativity over Cache Size

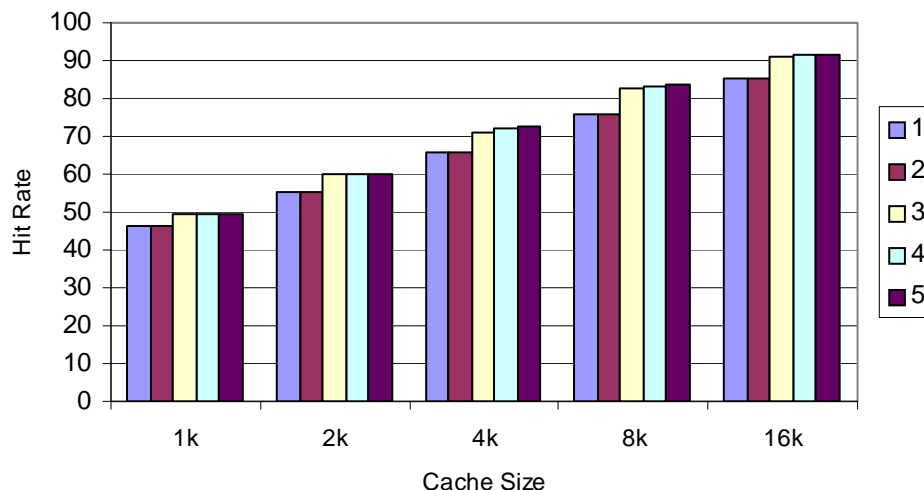


Figure 3. Zooming in on Associativity versus Cache Size

With a 4-Kbytes cache size, the difference between 3- and 5-way set associativity is miniscule compared to doubling the cache size. The complexity of the cache increases in proportion to the associativity, and in this case, would not be justifiable against increasing cache size to 8 or even 16 Kbytes.

3 Writes to Cache

Coherency and speed are chief concerns with writes in cache architecture. Coherency is the consistency of data between cache and memory. This is more important in multi-processor systems with shared memory, or in systems where integrated peripherals on a CPU core all share memory. Because reads dominate processor accesses, caches are usually optimized to speed up read accesses. For example, all instruction fetches are read accesses, and most instructions do not write to memory.

There are two cache designs used for writes:

- **Write Through**—writes to both the cache and the memory on every write access, regardless of a cache hit or miss. The writes to main memory ensure coherency but slow the speed of the processor by accessing RAM for every write.
- **Copy Back**—writes data only to the cache. This cache design writes data only to memory when the cache block is replaced or when another device needs access to this block of memory. Data writes to RAM once the cache block is replaced, reducing main memory accesses. The major advantage of a copy back cache is speed. Write cycles become much faster than if main memory had to be written to for every write. In addition, the processor is on the memory bus much less of the time, which becomes a great advantage in multiprocessor systems sharing a main memory bus.

For all of its advantages, copy-back caches require more complexity in tracking data written to cache but not to main memory. The modified bit, or dirty bit, is one method devised for memory housekeeping purposes. In such a method, an extra bit is used for each cache entry. Data that has been written to the cache, but not to main memory, is considered modified and is tagged as such by this extra bit. During a cache miss, or if the cache entry is about to be replaced, the dirty bit is checked to see if data first must be written to memory.

Although implementing a dirty bit is a simple way to maintain coherency, the increased complexity increases access latency.

4 Multi-Level Caches

Cache design is a cost/performance trade off. Processor designers confront design decisions of cost of wafer space and eventual die size, versus on-chip cache size. Board designers confront the cost of high speed memory. The typical board designer uses huge blocks of inexpensive SDRAM for instruction and program storage. Therefore to minimize the access time of the main memory during processor cache misses, the designer can use some tricks such as interleaving SDRAM memory. Interleaving involves keeping multiple SDRAM pages open at one time, minimizing precharge commands and speeding accesses to open SDRAM pages. But there is inherent complexity in keeping multiple pages open and performance degrades significantly with accesses to closed pages. Eliminating precharges on a handful of SDRAM pages can only speed things up so much. Even greater performance can be achieved by building an off-chip cache of faster memory outside the processor, an L2 (Level 2) cache, to accelerate the access time of SDRAM during on-chip misses.

Other than saving die space, a multi-level caching scheme is advantageous when examined with a cost/performance mindset. Typically a processor designer must choose between a small, fast cache and a large, slow one. The larger the RAM, the more logic required for its address decodes, and the longer the critical path, increasing latency. Large RAM arrays tend to be slower than small ones. Processor design typically results in a small fast cache followed by a larger (but slower) downstream cache. Even within a single processor core, two levels of on-chip cache are not necessarily of the same speed.

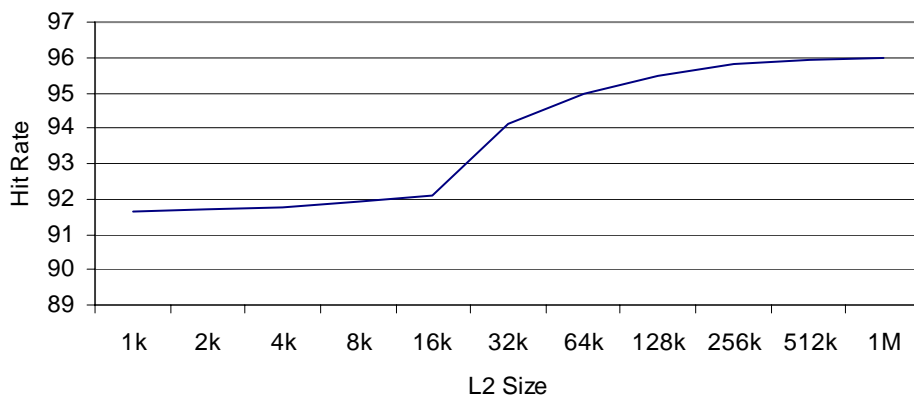


Figure 4. 16 Kbyte L1 versus L2

In the two-level cache system simulation shown in [Figure 4](#), the 16 Kbyte L1 cache exhibits a 92% hit rate, meaning that 8% of total traffic gets to the secondary cache. By adding a secondary cache that is four times larger than the L1, the total hit rate improves to 95%. The total miss rate is now 5%, or only 3% better, which means that the secondary cache has a hit rate of about 38%. At first glance, the 3% improvement with a multi-level cache seems insignificant, but miss rate drops from 8% in a single-level system to 5% in the two-level system, or roughly by 40%. This means that bus traffic in the two-level system is about 40% less than that of in the single-level system, which is significant in a multiprocessing architecture where more than one resource shares the bus.

The hit rates for the above example are fictitious data. Actual hit rate is a factor of the cache hardware, as well as the compiler and the end code. [Section 4.1, “L1 and L2 Simulations,”](#) shows examples of cache simulations and their resultant hit rates.

It is easy to see the benefits of a multi-level cache in eliminating main memory traffic. In the world of cost/performance trade-offs and slow inexpensive main memory, minimizing main memory accesses through a fast multi-level cache provides increased performance to the CPU, sometimes even greater than raw clock cycles.

4.1 L1 and L2 Simulations

Figure 5 shows simulated values for cache hits running two popular algorithms, the Spice electronics simulator, and the GCC compiler. Cache hit ratios takes the shape of an elongated S curve, asymptotically approaching a point at which doubling cache size makes little impact on the total number of hits to the cache.

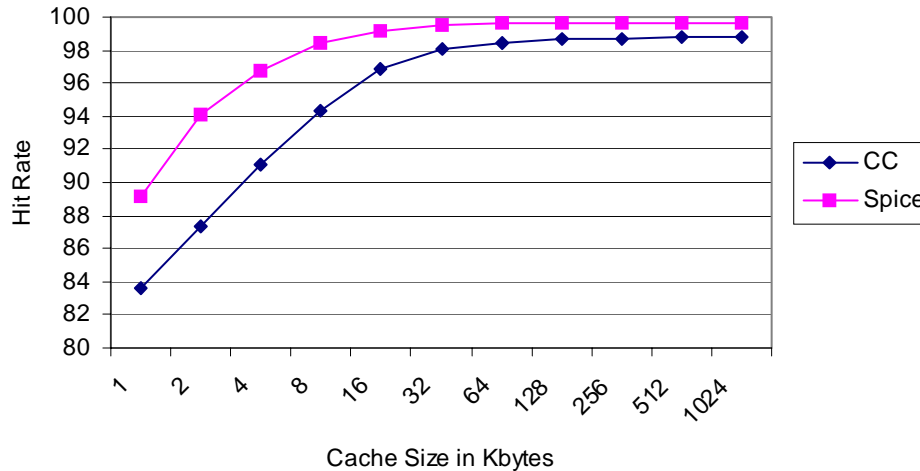


Figure 5. L1 Cache Hits

Figure 6 shows L2 hit rates for a fixed 1 Kbyte L1 cache size while running the GCC compiler. Notice again that the L2 hit rate takes the form of an elongated S curve. In the example below, once the L2 cache size reaches about 32 Kbytes, it no longer makes a significant impact on the total hit rate.

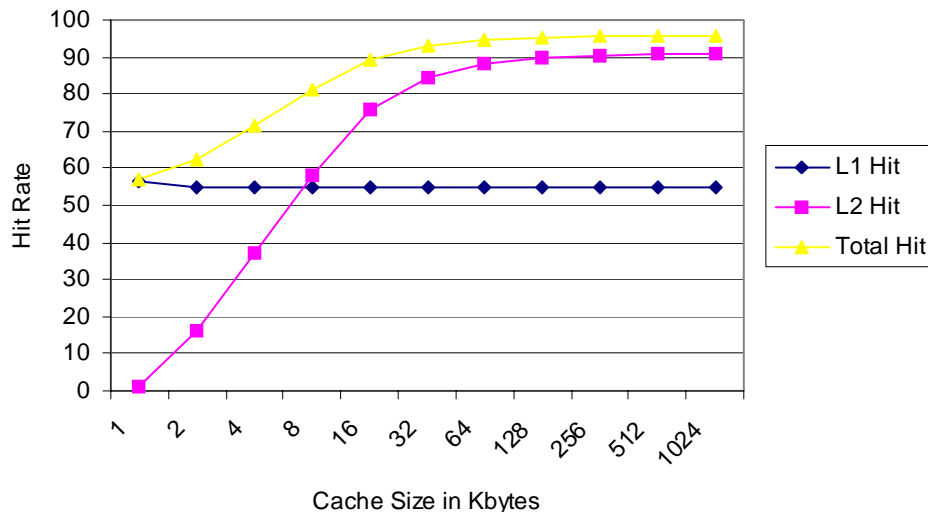


Figure 6. Hit Rates for Increasing L2 Cache Size, with 1 Kbyte L1

Figure 7 shows a three-dimensional view of cache hits while changing both L1 and L2 cache size. Again, this algorithm peaks out at just under 96% cache hits. This is due to the nature of the specific algorithm being simulated. It is interesting to see that a 16 Kbyte L1 with a 1 Kbyte L2 gives almost the same results (91% hits) as a 1 Kbyte L1 with an L2 of 16 Kbytes (89% hits).

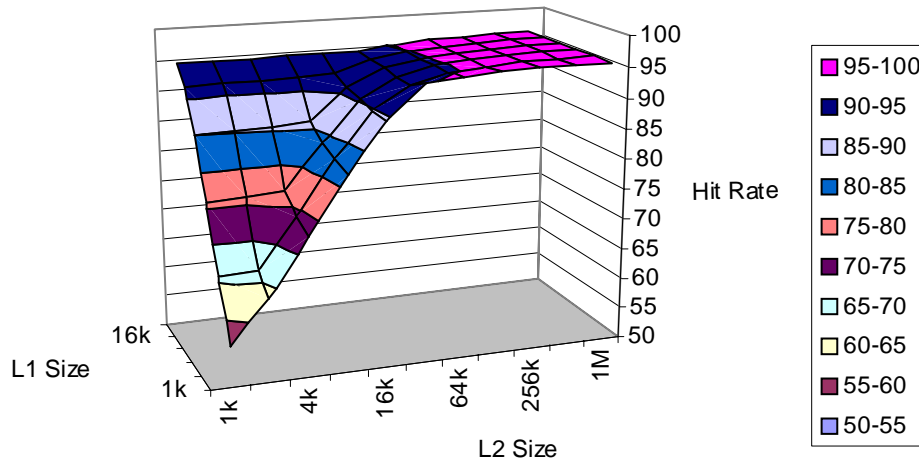


Figure 7. Hit Rates for Changing L1 and L2 Size

Perhaps the most educating aspect of this exercise is in noticing the impact of L2 to total hits with respect to L1 size. L2 has little effect on the total number of cache hits until it is at least double the L1 cache size. As seen in Figure 8, the steepest part of the slope for an L1 cache of 8 Kbytes, is for an L2 cache of 16 Kbytes. Again for an L1 cache of 16 Kbytes, the steepest part of the curve is for an L2 cache size of 32 Kbytes. Prior to that point, the L2 cache has little, if any, impact on total cache performance. Since the L2 cache has the same line size as the L1 cache, the only hits on the downstream cache are from L1 cache misses caused by conflicts in the L1. The L2 cache is essentially filled with the same data as the L1 cache, at the time it is loaded into the L1 cache. The only way that this data can stay in the L2 cache, but be removed from the L1 cache, is if the primary cache has a conflict that necessitates rewriting its copy of the cache line. To ensure that the same conflict does not rewrite the L2 cache, the L2 cache needs to be considerably larger, either containing a larger address space or a larger line size.

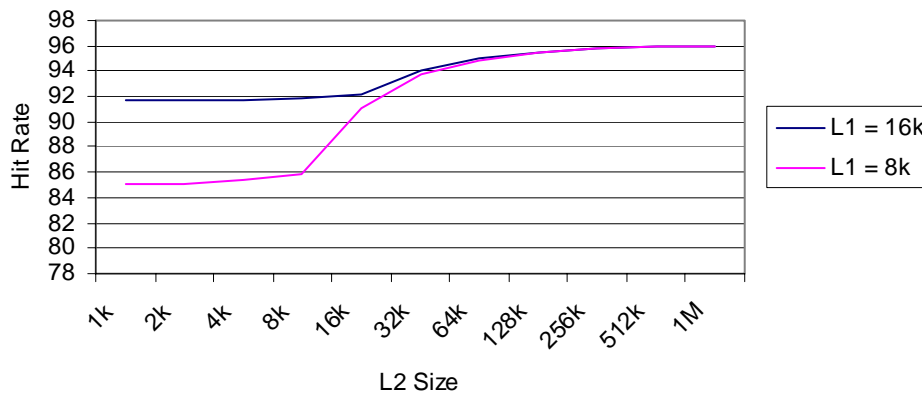


Figure 8. Total Hits (L1 and L2) for 8 Kbyte and 16 Kbyte L1

It is important to remember that these graphs are the result of a simulation, and not actual measured data. The simulation has a flaw in that it allows the cache enormous spatial locality within the code. On a real system, a processor would most likely be running an Operating System, and handling more than one task at a time. Upon each task switch from one thread to another, locations in cache would be flushed and then re-issued to new memory locations corresponding to the new thread. In addition the OS, would be running and would most likely use some

space in cache. In the above examples, both the GCC compiler and Spice only occupied a few Kbytes of code space each. When cache size reaches about 16 Kbytes, the whole instruction space seems to fit within cache. 100% of instruction hits is never achieved, mainly because associativity was kept at two. The code spans multiple Kbytes and thus has overlapping set addresses. Figure 9 shows the split between instruction and data hits for an associativity of 2. Notice that instruction and data hits both taper off at just under 100%. Increasing the instruction cache size from 64 Kbytes to 1 Mbyte makes little difference in performance. Increasing associativity to 4 from 2 increases the hit rate from a maximum of 98.6% to 98.8% (not shown). Other factors such as block size and replacement algorithm can also help in achieving higher hit rates.

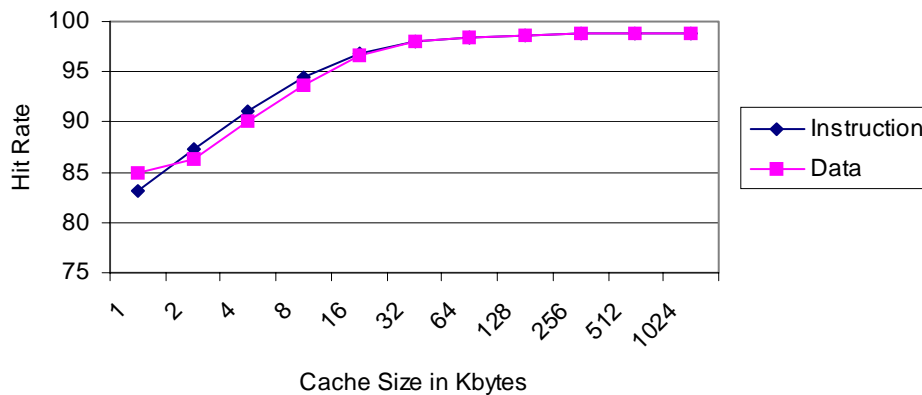


Figure 9. Instruction versus Data Hits for L1 Cache

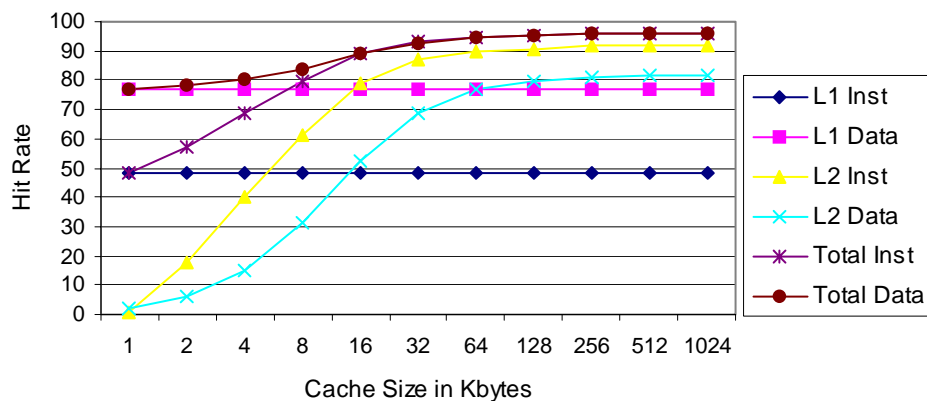


Figure 10. L2 Instruction versus Data Cache Hits (Varying L2 size)

NOTE

The previous figures were all created on a cache simulator while simulating the GCC compiler. The L1 cache is configured as two 2-way set-associative independent caches (instruction and data), with block size of 4. The L2 cache is configured as a unified cache, block size of 4, 2-way set-associative.

5 Frontside versus Backside Cache

When designing cache between the core and the memory subsystem, there is a trade off in its placement and two different architectures have emerged.

A frontside cache is implemented inline with the memory system as modeled in [Figure 11](#).

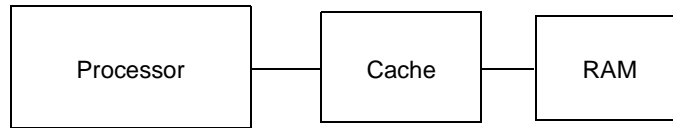


Figure 11. Frontside Cache

This configuration is so named because of the cache’s situation on the frontside bus, or memory bus, of the microprocessor. Typically, the frontside bus runs at a fraction of the processor speed. For instance, on the PowerQUICC II™ processor it is likely that the processor core runs at 200 MHz, while using only a 66 MHz bus speed. The frontside cache, also runs at the frontside speed of 66 MHz.

In comparison, a backside cache is typically implemented through a dedicated bus, separate from the main memory bus as configured in [Figure 12](#).



Figure 12. Backside Cache

Because it is on a dedicated bus, a backside cache is typically clocked faster than the main system (frontside) bus. With for example, Freescale’s MPC7410 microprocessor, it is possible to run the core at 400 MHz, with a 133 MHz frontside bus, and a 400 MHz backside bus. This means that the off-chip L2 cache can run at the full core rate of 400 MHz.

6 Example Cache Implementation: PowerQUICC III™

At the heart of the PowerQUICC III is the e500 core, containing separate data and instruction caches, which are 32-Kbyte, eight-way set-associative L1 caches. In addition, the PowerQUICC III is the first processor in Freescale’s PowerQUICC family of processors to incorporate an on-chip L2 cache. [Figure 13](#) shows a diagram of the e500 core and caches.

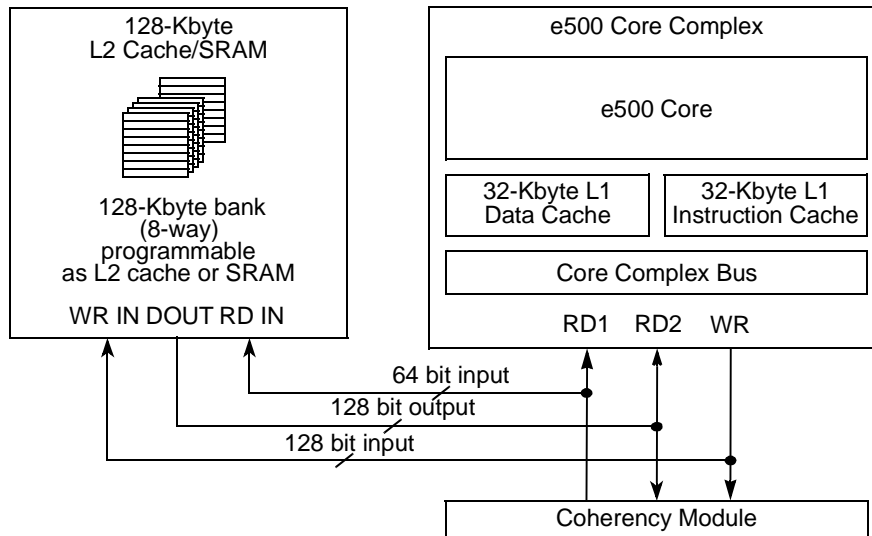


Figure 13. e500 Core and Caches

6.1 L1 Caches

The e500 core features an integrated L1 cache, designed as a Harvard architecture so as to have a separate L1 data and instruction cache. Each L1 cache is 32-Kbyte and eight-way set associative.

The following are some features of both the L1 data and instruction caches:

- 32-Kbyte size
- Eight-way set associative
- Pseudo least recently used (PLRU) replacement policy
- Cache block size is 32 bytes (8 words)
- Individual line locking
- Parity generation and checking

Figure 14 shows the basic L1 cache organization.

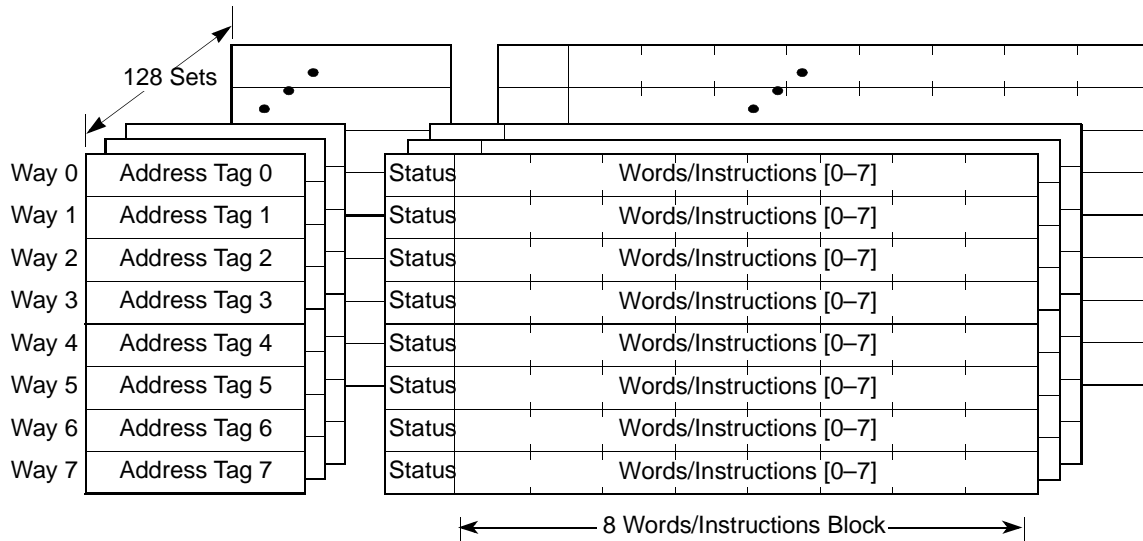


Figure 14. L1 Cache Organization

Note: The status bits are different in the data and instruction caches. The data cache supports three-state MEI memory coherency protocols with 3-bit status and 1-bit coherency valid fields. The instruction cache has only a 1-bit coherency valid field and eight instructions in a block.

Each block of data cache consists of 32 bytes of data, three status bits, one lock bit, and an address tag. The data cache supports three-state MEI coherency. For the L1 data cache, a cache block is a 32-byte cache line containing 8 contiguous words from memory. Data cache has one parity bit per word (not shown in Figure 14). Physical address bits 20–26 provide an index to select a cache set. Tags consist of physical address bits 0–19. Address bits 27–31 locate a byte within the selected block.

Additionally, the data cache supports hit-under-miss conditions. Hit-under-miss is a capability that permits the core to access the cache while a fill for an earlier miss is pending. Up to four misses can be pending in the load miss queue.

The instruction cache is organized similarly to the L1 data cache. Each block consists of eight instructions, one status bit, one lock bit, and an address tag. For the L1 instruction cache, a cache block is a 32-byte cache line containing 8 contiguous words from memory. The instruction cache has one parity bit per word (not shown in Figure 14). Physical address bits 20–26 provide an index to select a cache set. Tags consist of physical address bits 0–19.

The instruction cache also allows for hit-under-miss conditions.

The e500 registers L1CSR0 and L1CSR1 provide for cache configuration and control of the L1 caches as defined by the Freescale Book E standard. Descriptions of these registers can be found in the *MPC8560 PowerQUICC III Integrated Communications Processor Reference Manual*.

In addition, L1CFG0 is a read-only register that allows software to read the status of the L1 cache. Information such as line size, cache replacement policy, Harvard or unified, are available to enable software to make decisions and use the cache appropriately. This will become more useful as new derivatives of the e500 core are put into use.

6.2 L2 Cache

In addition to the L1 caches integrated in the e500 core, the PowerQUICC III provides an on-chip unified L2 cache. The following are features of the L2 cache:

- 256-Kbyte unified cache can be configured for instructions, data, or both
- write-through
- frontside cache
- Pseudo-least-recently-used (PLRU) replacement policy
- Data protected by ECC
- Tags protected by parity
- Fully Pipelined, nonblocking (allows hits under misses)
- Individual line locking

The L2 cache resides on the frontside bus of the e500 core. In previous sections of this document, differences between frontside and backside cache architectures are described. The frontside cache is designed to run at main memory bus speed. However, the frontside design allows for easy access to the cache from I/O masters such as gigabit Ethernet, RapidIO, and the CPM. In addition, the frontside design allows the flexibility to share data between cores in future dual core architectures. The frontside architecture in the PowerQUICC III allows for more performance with less complexity, thereby lowering die size and in turn, cost and power.

6.2.1 L2 Organization

The PowerQUICC III's L2 cache is organized as two banks of 512 sets each, both containing eight ways as shown in [Figure 15](#). Each block consists of 32 bytes of data and an address tag.

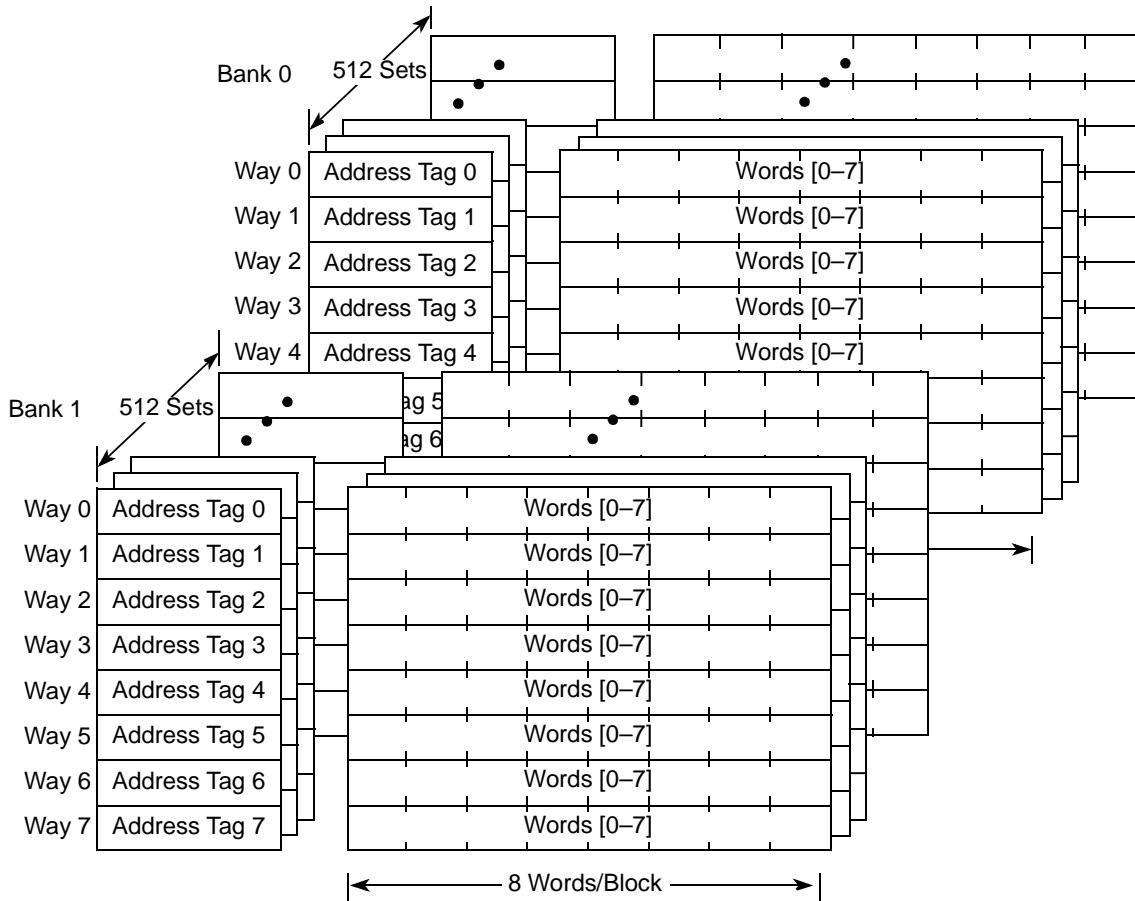


Figure 15. L2 Cache Organization

In addition, the L2 cache array allows the option of being partitioned into private on-chip SRAM. It can be partitioned into one 256 Kbyte region, or two 128 Kbyte regions (residing at any aligned location within the memory map). I/O devices access the SRAM by marking data snoopable (global).

6.3 Buses to the L2 Cache

In [Figure 13](#), there are three buses between the PowerQUICC III's coherency module, L2 cache, and e500 core. These are described as a 64-bit input bus, a 128-bit input bus, and a 128-bit output bus, and are referred to with respect to the L2. Keep in mind that the DDR memory bus is 64 bits wide. The 128-bit datapaths were designed to provide twice the bandwidth of DDR, allowing L2 traffic to be serviced without impacting bandwidth to DDR.

The 128-bit output bus is intended for use with L1 data that is castout to L2 cache or DDR memory. It is also used for uncached write data to either I/O or DDR memory.

L2 data is provided to the e500 core through the 128-bit input bus upon an L1 miss and L2 hit. In this case, L2 data is provided to the core critical double-word first. Data is available for execution without waiting for the entire L1 cache line to be reloaded. The 128-bit bus is also used in the case of a read from L2 for I/O snooped responses or an e500 read of L2 SRAM.

The 64-bit input bus is sized to the DDR bus. It is used in the case of an L2 miss (where data would be allocated to L1 and L2), an I/O stash to L2, an I/O write to L2 SRAM, or uncached read data to the CPU. Data is supplied critical-word first. All three buses operate at 333 MHz, the DDR data rate.

7 References

Handy, Jim, *The Cache Memory Book*, pp. 8–21, 64–66, 89–94, Academic Press Inc. 1998.

Hennessy, John and David Patterson, *Computer Architecture: A Quantitative Approach*, pp. 372–441, Morgan Kaufmann 1995.

MPC8560 PowerQUICC III Integrated Communications Processor Reference Manual (MPC8560RM)

PowerPC™ e500 Core Complex Reference Manual (E500CORERM)

8 Revision History

Table 2 provides a revision history for this application note.

Table 2. Document Revision History

Revision Number	Date	Substantive Change(s)
1	10/04/2004	Initial release

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